

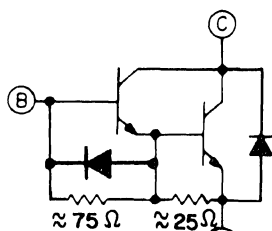


# HIGH SPEED NPN POWER DARLINGTON TRANSISTORS

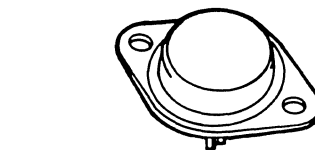
**GE6060,1,2**

**400-500 VOLTS  
20 AMP, 125 WATTS**

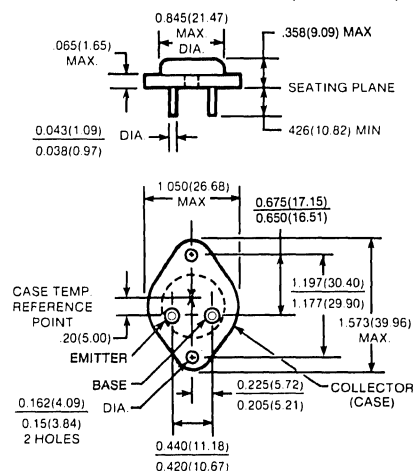
These devices are designed for use in high speed switching applications, such as off-line switching power supplies, AC & DC motor control, UPS systems, ultrasonic equipment and other high frequency power conversion equipment.



**DEVICE CIRCUIT**



**CASE STYLE TO-204AA (TO-3)**  
DIMENSIONS ARE IN INCHES AND (MILLIMETERS)



maximum ratings ( $T_C = 25^\circ\text{C}$ ) (unless otherwise noted)

RATING	SYMBOL	GE6060	GE6061	GE6062	UNITS
Collector-Base Voltage	$V_{CBO}$	400	450	500	Volts
Collector-Emitter Voltage	$V_{CEO}$	350	400	450	Volts
Emitter Base Voltage	$V_{EBO}$	5	5	5	Volts
Collector Current — Continuous	$I_C$	20	20	20	A
Peak (Repetitive)	$I_{CM}$	25	25	25	
Peak (Non-Repetitive)	$I_{CSM}$	42.5	42.5	42.5	
Base Current — Continuous	$I_B$	4	4	4	A
Peak (Non-Repetitive)	$I_{BM}$	6	6	6	
Total Power Dissipation @ $T_C = 25^\circ\text{C}$	$P_D$	125	125	125	Watts
Operating and Storage Junction Temperature Range	$T_J, T_{STG}$	-65 to +150	-65 to +150	-65 to +150	$^\circ\text{C}$

## thermal characteristics

Thermal Resistance, Junction to Case	$R_{\theta JC}$	1	1	1	$^\circ\text{C/W}$
Maximum Lead Temperature for Soldering Purposes: $\frac{1}{8}$ " from Case for 5 Seconds	$T_L$	300	300	300	$^\circ\text{C}$

electrical characteristics ( $T_C = 25^\circ\text{C}$ ) (unless otherwise specified)

CHARACTERISTIC	SYMBOL	MIN	TYP	MAX	UNIT
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off characteristics

Collector-Emitter Sustaining Voltage ( $I_C = .5\text{mA}$ ) ( $V_{\text{clamp}} = V_{\text{CEO Rated}}$ )	GE6060 GE6061 GE6062	$V_{\text{CEO(sus)}}$	350 400 450	— — —	— — —	Volts
Collector-Base Voltage ( $I_C = 0.25\text{mA}$ )	GE6060 GE6061 GE6062	$V_{\text{CBO}}$	400 450 500	— — —	— — —	Volts
Collector Cutoff Current ( $V_{\text{CB}} = V_{\text{CBO Rated}}$ )		$I_{\text{CBO}}$	—	—	0.25	mA
Emitter Cutoff Current ( $V_{\text{EB}} = 1.5\text{V}$ , $I_C = 0$ )		$I_{\text{EBO}}$	—	—	200	mA

second breakdown

Second Breakdown with Base Forward Biased	FBSOA	SEE FIGURE 14
Clamped Inductive soa with Base Reversed Bias	RBSOA	SEE FIGURE 17

on characteristics

DC Current Gain ( $I_C = 10\text{A}$ , $V_{\text{CE}} = 5\text{V}$ ) ( $I_C = 15\text{A}$ , $V_{\text{CE}} = 5\text{V}$ ) ( $I_C = 20\text{A}$ , $V_{\text{CE}} = 5\text{V}$ )	$h_{\text{FE}}$	40 30 10	160 115 65	— — —	—
Collector-Emitter Saturation Voltage ( $I_C = 10\text{A}$ , $I_B = 1\text{A}$ ) ( $I_C = 10\text{A}$ , $I_B = 2\text{A}$ ) ( $I_C = 20\text{A}$ , $I_B = 2\text{A}$ )	$V_{\text{CE(sat)}}$	— — —	1.2 1.15 1.6	1.5 1.4 2	V
Base-Emitter Voltage ( $I_C = 5\text{A}$ , $I_B = .5\text{A}$ ) ( $I_C = 20\text{A}$ , $I_B = 2\text{A}$ )	$V_{\text{BE(sat)}}$	— —	1.95 2.3	2.5 3.5	V

switching characteristics

Resistive Load					
Rise Time	$V_{\text{CC}} = 300\text{V}$ , $t_p = 50 \mu\text{s}$ $I_C = 15\text{A}$ , $I_{\text{B1}} = 1.5\text{A}$ , $I_{\text{B2}} = 2.25\text{A}$	$t_r$	—	0.3	0.4
Storage Time		$t_s$	—	2.3	2.5
Fall Time		$t_f$	—	0.5	1.0
Inductive Load, Clamped					
Storage Time	$V_{\text{CC}} = 300\text{V}$ , $L = 100 \mu\text{H}$ $I_C = 15\text{A}$ , $I_{\text{B1}} = 1.5\text{A}$ , $I_{\text{B2}} = 2.25\text{A}$	$t_s$	—	2.6	—
Crossover Time		$t_c$	—	0.5	—
Fall Time		$t_f$	—	0.12	—

emitter-collector diode characteristics

Forward Voltage $I_F = 10\text{A}$ $I_F = 25\text{A}$	$V_F$	— —	1.9 2.8	— —	Volts
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# TYPICAL CHARACTERISTICS

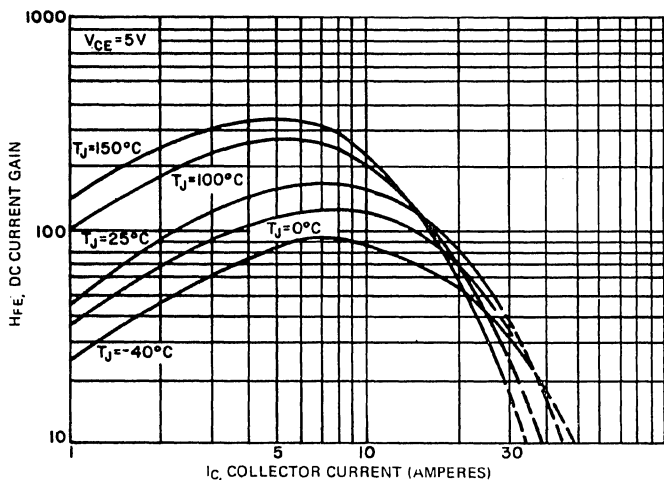


FIGURE 1. DC CURRENT GAIN ( $V_{CE} = 2V$ )

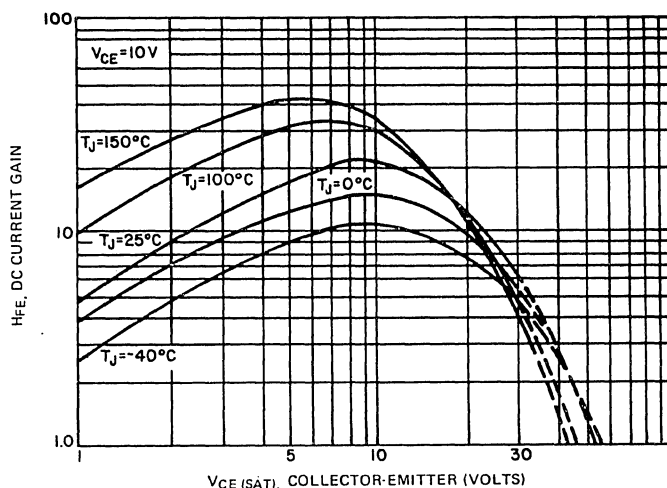


FIGURE 2. DC CURRENT GAIN ( $V_{CE} = 10V$ )

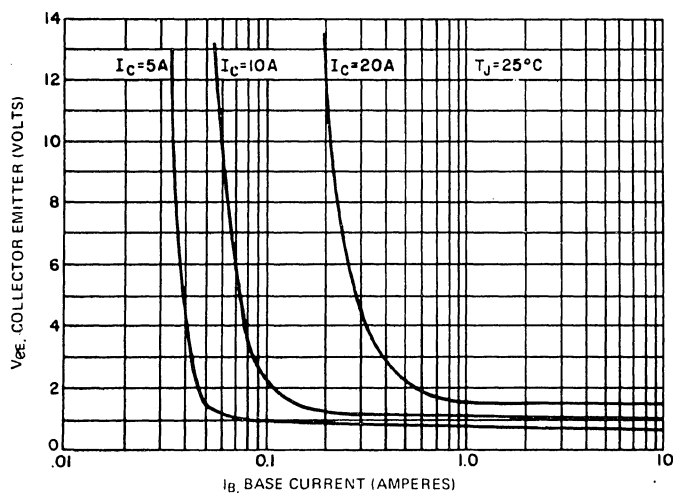


FIGURE 3. COLLECTOR SATURATION REGION

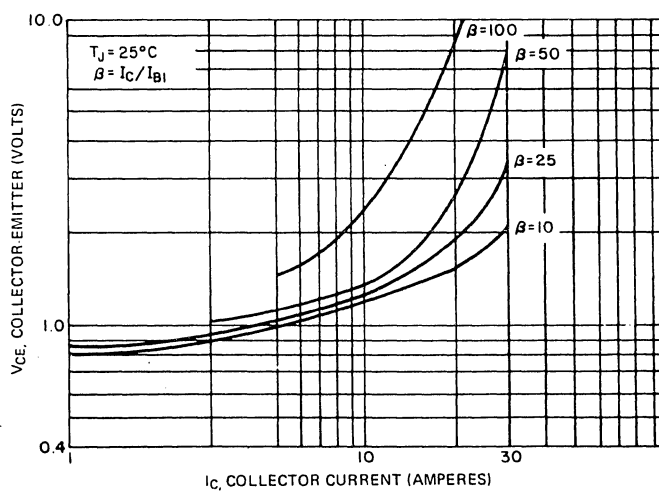


FIGURE 4.  $V_{CE(SAT)}$  VS.  $I_C$ ,  $T_J = 25^\circ C$

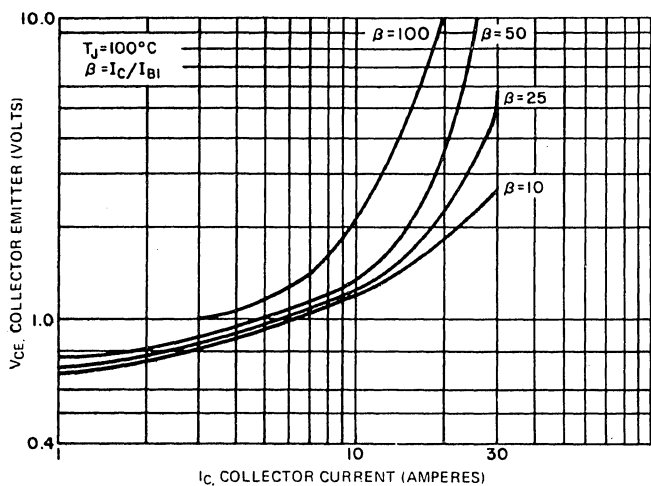


FIGURE 5.  $V_{CE(SAT)}$  VS.  $I_C$ ,  $T_J = 100^\circ C$

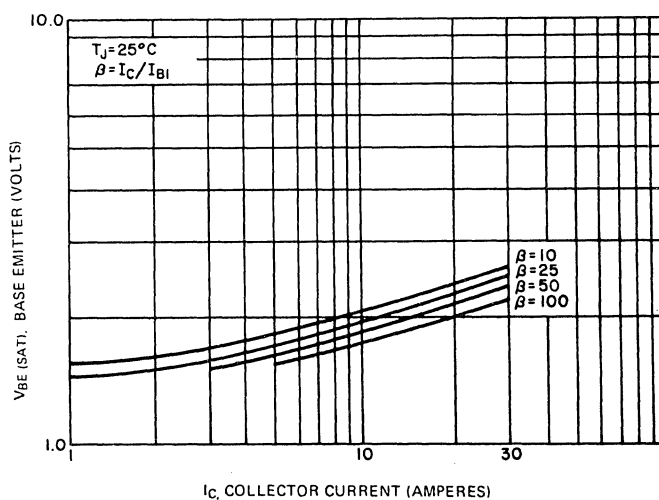


FIGURE 6.  $V_{BE(SAT)}$  VS.  $I_C$ ,  $T_J = 25^\circ C$

# TYPICAL CHARACTERISTICS

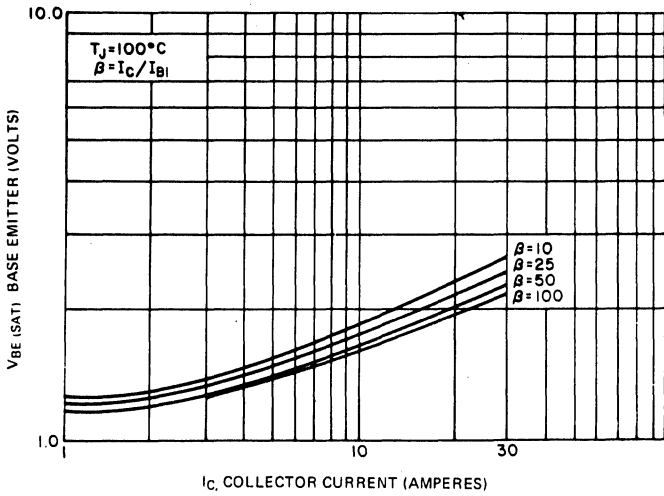


FIGURE 7.  $V_{BE(SAT)}$  VS.  $I_C$ ,  $T_J = 100^\circ\text{C}$

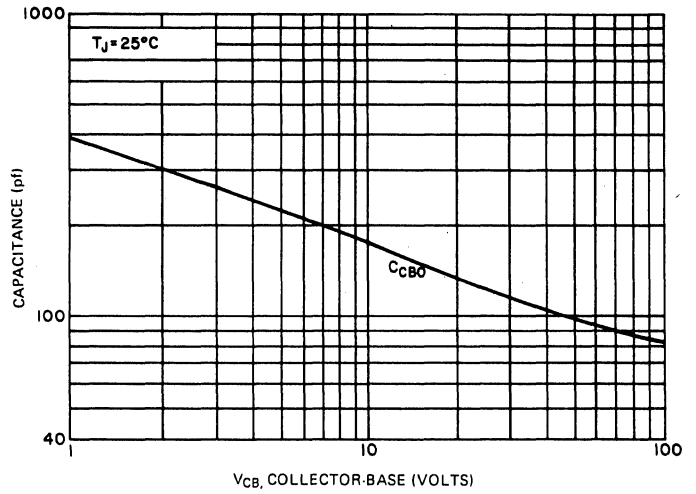


FIGURE 8. CAPACITANCE ( $C_{CB0}$ )

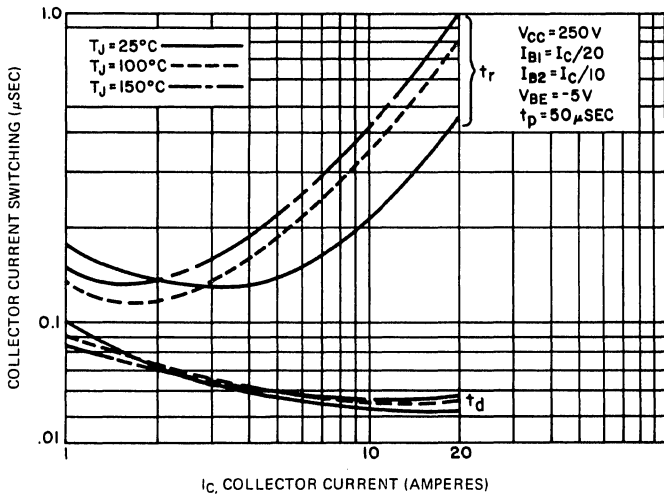


FIGURE 9. TURN-ON TIME (RESISTIVE)

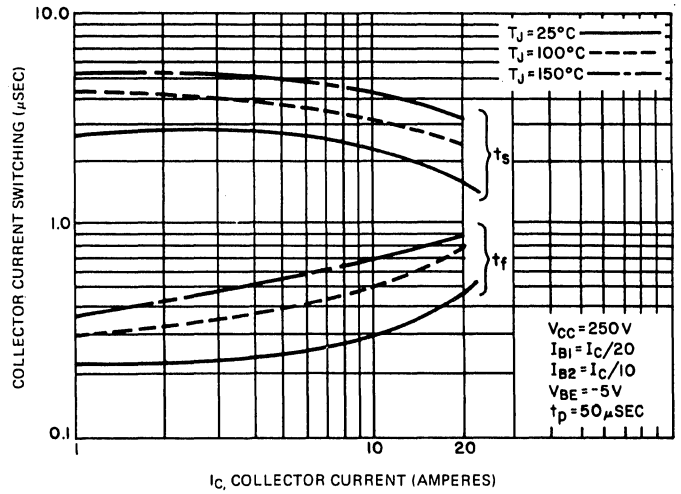


FIGURE 10. TURN-OFF TIME (RESISTIVE)

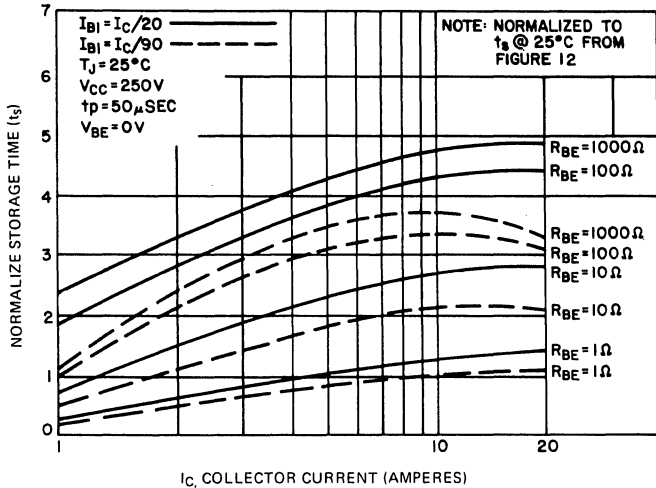


FIGURE 11. NORMALIZED RESISTIVE SWITCHING STORAGE TIME ( $R_{BE}$  VARIATIONS) VS. COLLECTOR CURRENT

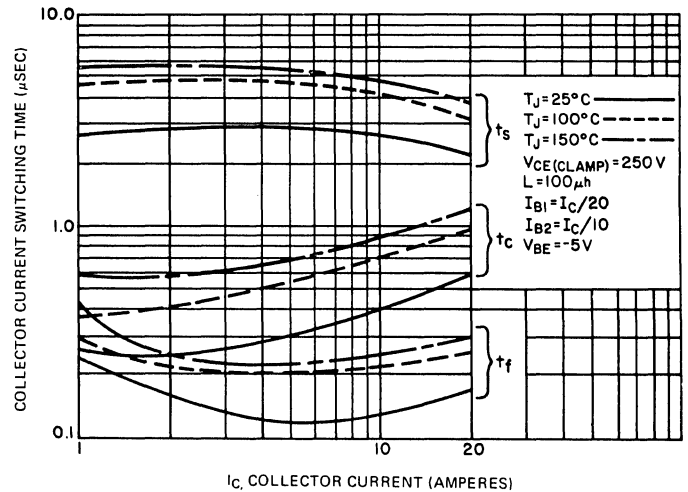
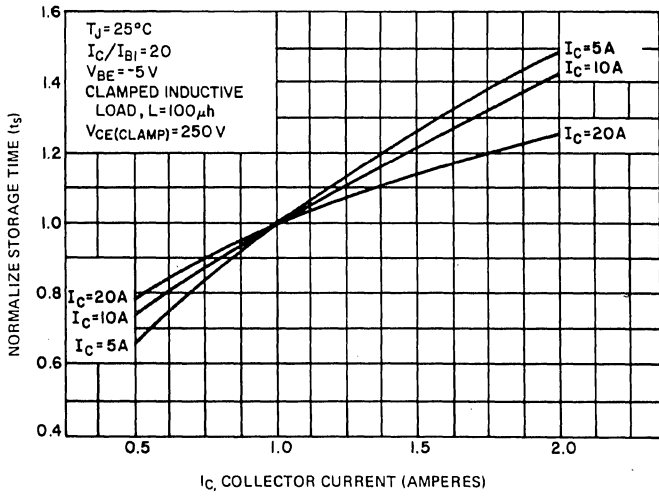
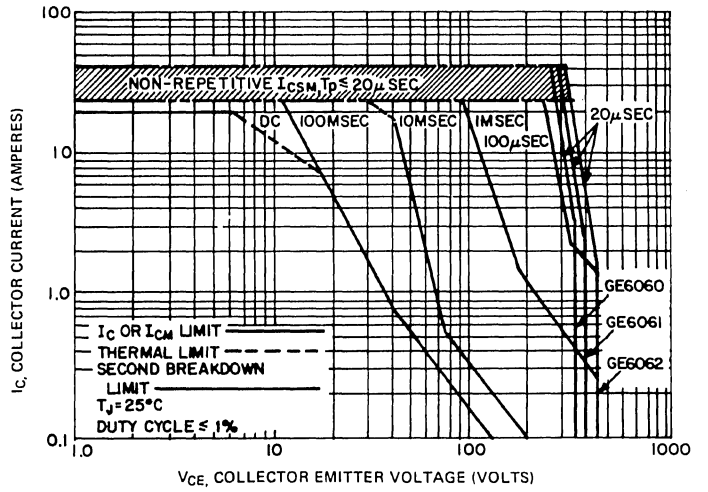


FIGURE 12. CLAMPED INDUCTIVE TURN-OFF TIME

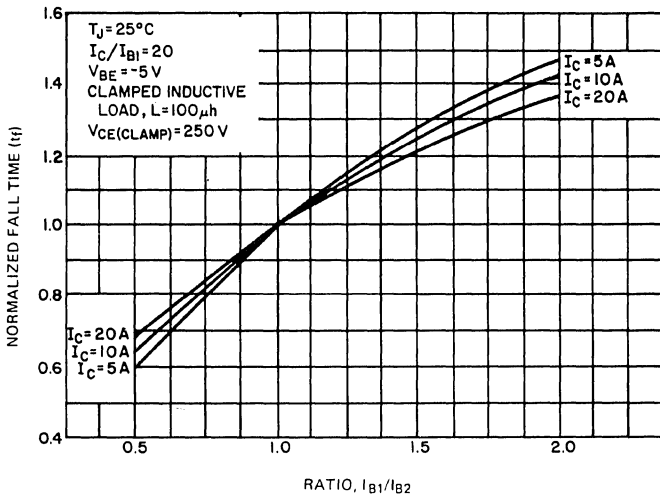
# TYPICAL CHARACTERISTICS



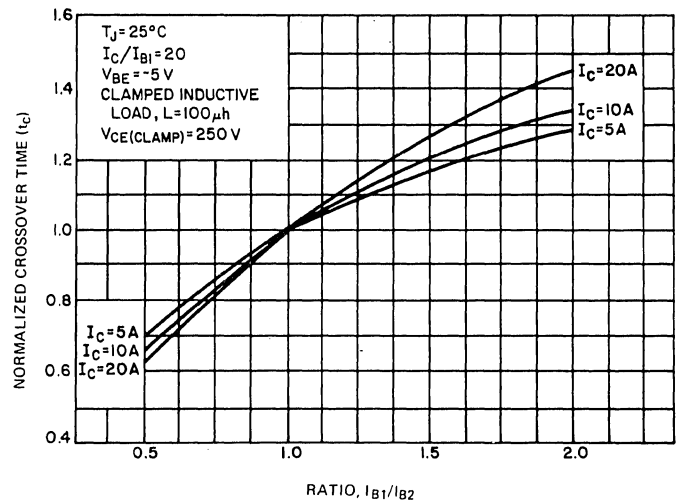
**FIGURE 13. STORAGE TIME VARIATION WITH  $I_{B2}$**



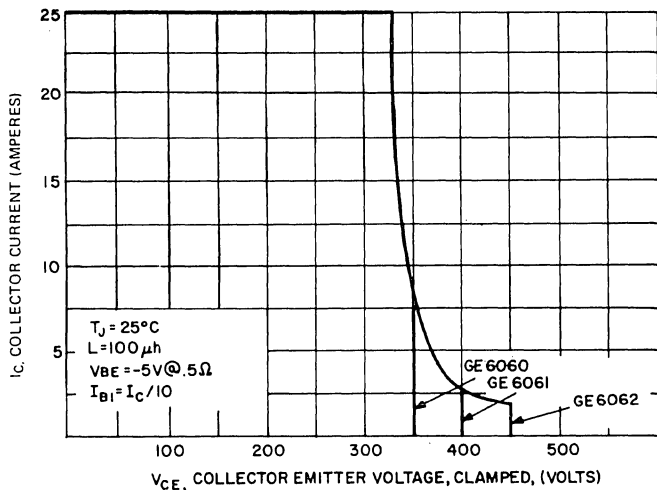
**FIGURE 14. FORWARD BIAS SAFE OPERATING AREA**



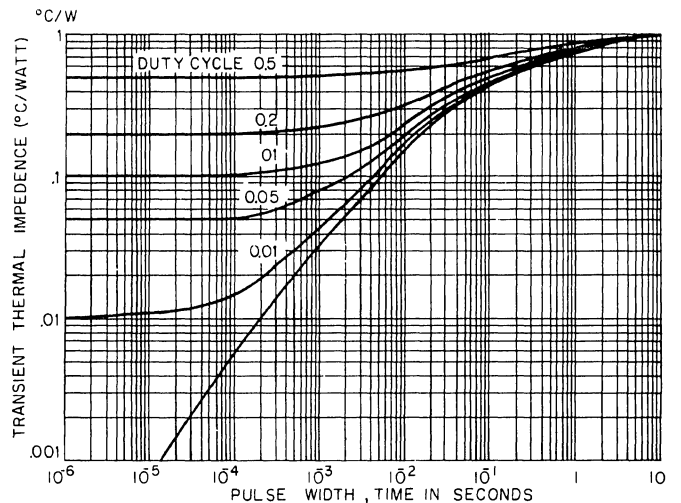
**FIGURE 15. FALL TIME VARIATION WITH  $I_{B2}$**



**FIGURE 16. CROSS-OVER TIME VARIATION WITH  $I_{B2}$**

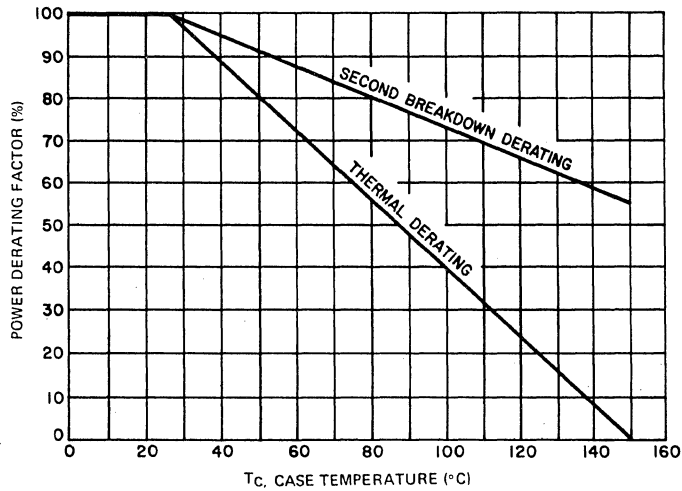


**FIGURE 17. REVERSE BIAS SAFE OPERATING AREA**



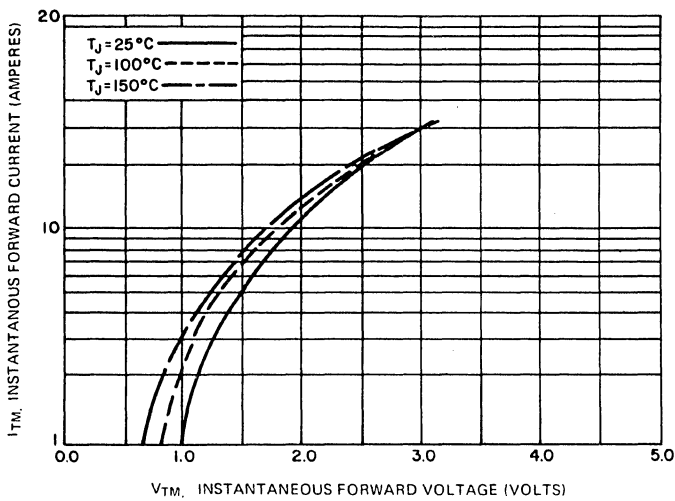
**FIGURE 18. TRANSIENT THERMAL RESPONSE**

## TYPICAL CHARACTERISTICS

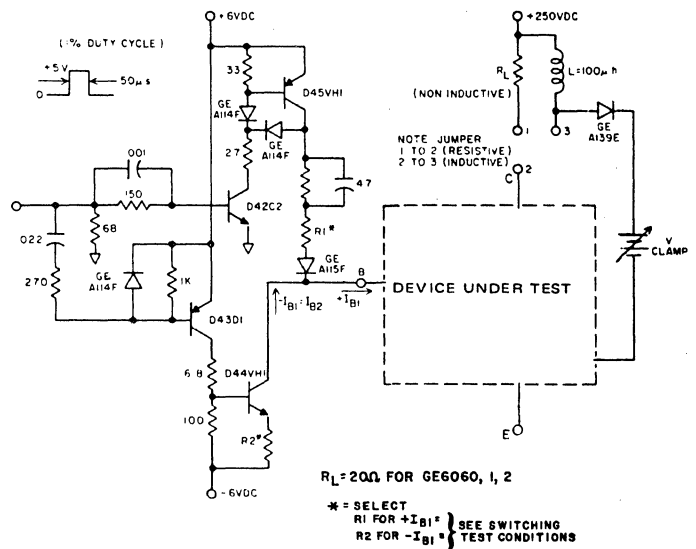


**FIGURE 19. POWER DERATING**

## DIODE CHARACTERISTICS



**FIGURE 20. FORWARD CHARACTERISTICS**



**FIGURE 21. SWITCHING TIME TEST CIRCUIT**